



## N-Channel Enhancement Mode Field Effect Transistor

### Product Summary

$V_{DS}$	30V
$I_D$	5.6A
$R_{DS(ON)}$ ( at $V_{GS}=10V$ )	24mohm
$R_{DS(ON)}$ ( at $V_{GS}=4.5V$ )	38mohm

### General Description

Trench Power LV MOSFET technology  
High density cell design for low  $R_{DS(ON)}$   
High Speed switching  
Moisture Sensitivity Level 1  
Epoxy Meets UL 94 V-0 Flammability Rating  
Halogen Free

### Applications

Battery protection  
Load switch  
Power management

### Absolute Maximum Ratings ( $T_A=25$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		$V_{DS}$	30	V
Gate-source Voltage		$V_{GS}$	$\pm 20$	V
Drain Current	$T_A=25$	$I_D$	5.6	A
	$T_A=70$		4.5	
Pulsed Drain Current <sup>A</sup>		$I_{DM}$	30	A
Total Power Dissipation	$T_A=25$	$P_D$	1.2	W
	$T_A=70$		0.8	W



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## Electrical Characteristics (T<sub>J</sub>=25 unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	30			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V			1	μA
Gate-Body Leakage Current	I <sub>GSS1</sub>	V <sub>GS</sub> =± 20V, V <sub>DS</sub> =0V			± 100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =250μA	1	1.5	2.2	V
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =5.6A		17	24	m
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =5A		26	38	
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =5.6A, V <sub>GS</sub> =0V			1.2	V
<b>Dynamic Parameters</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, f=1MHZ		526		pF
Output Capacitance	C <sub>oss</sub>			78		
Reverse Transfer Capacitance	C <sub>rss</sub>			69		
<b>Switching Parameters</b>						

Total Gate Charge

Q<sub>g</sub>

V<sub>GS</sub>=10



Typical Performance Characteristics

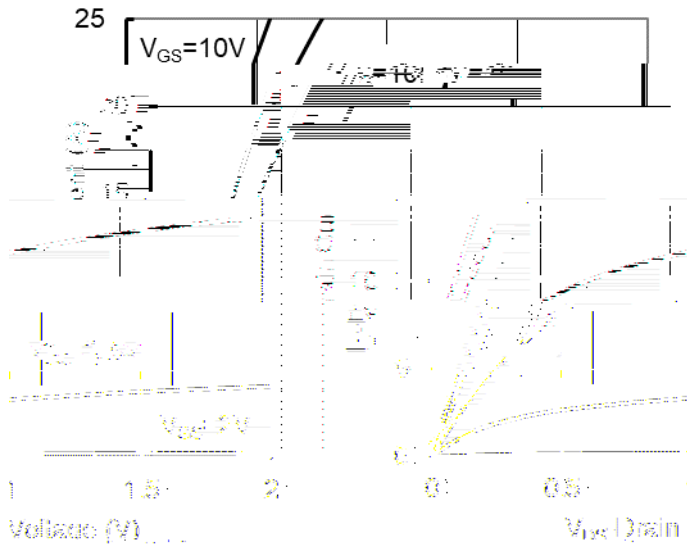


Figure1. Output Characteristics

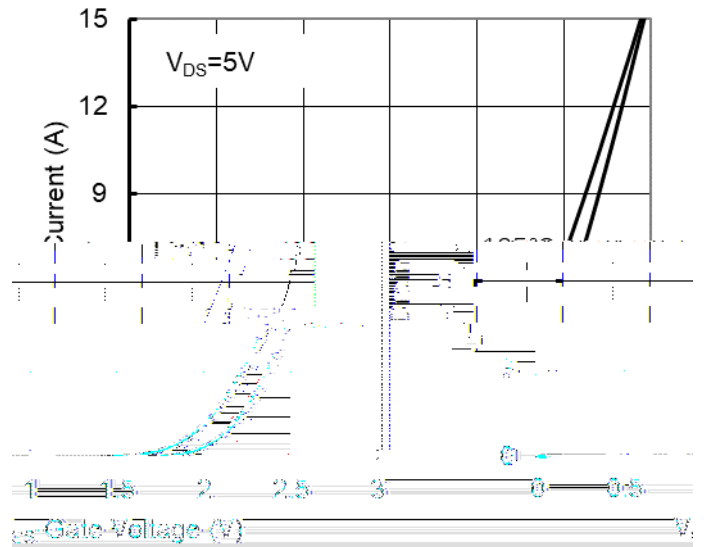


Figure2. Transfer Characteristics



Figure 3: On-Resistance vs. Drain Current and Gate Voltage

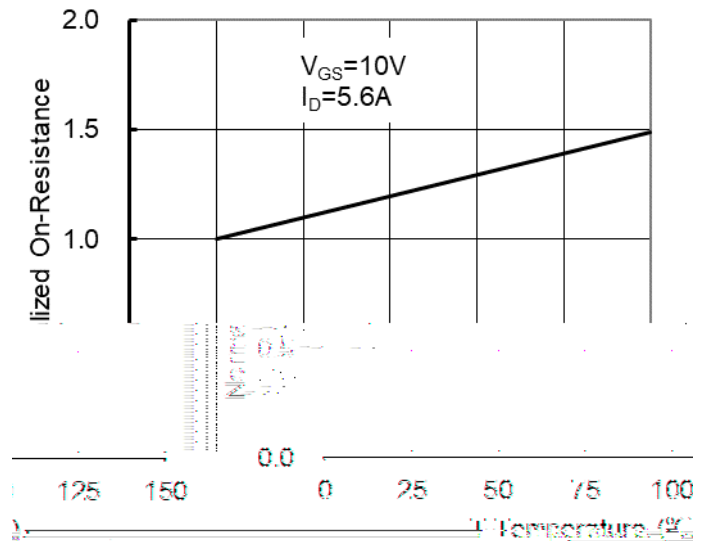
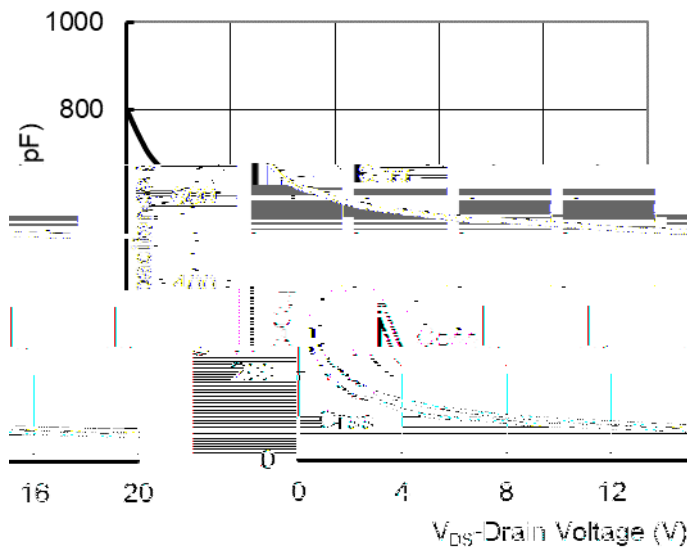


Figure 4: On-Resistance vs. Junction Temperature



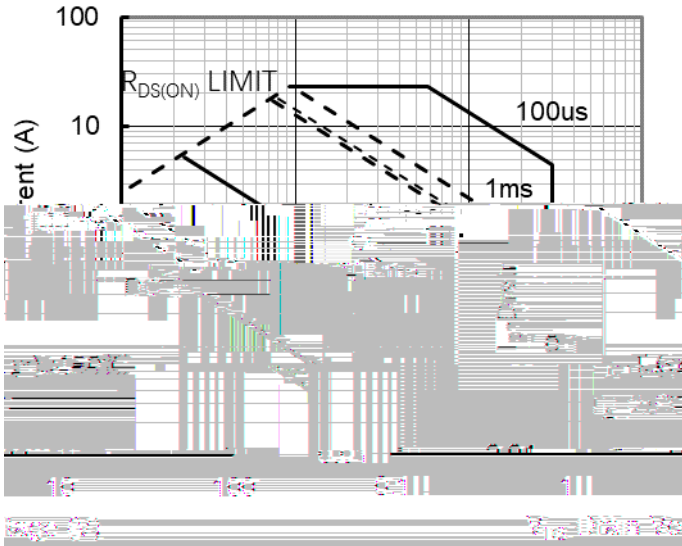


Figure7. Safe Operation Area

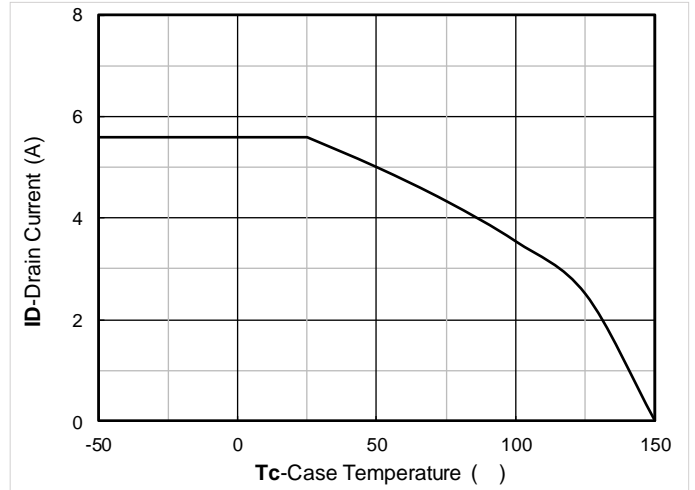


Figure8. Maximum Continuous Drain Current vs Ambient Temperature

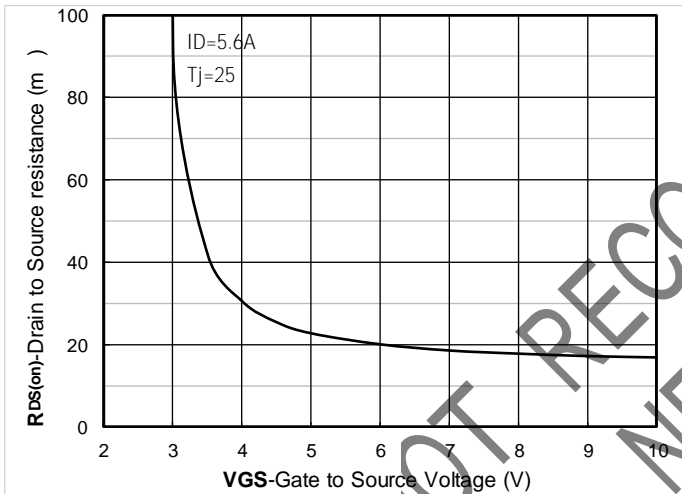


Figure 9. On-Resistance vs Gate to Source Voltage

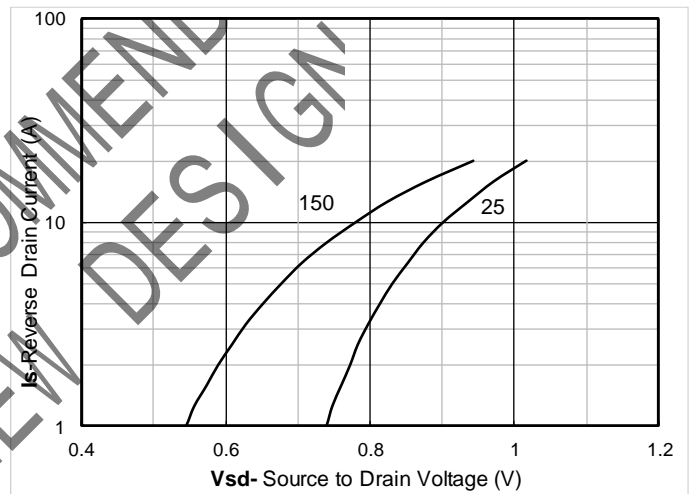


Figure 10. Forward characteristics of reverse diode

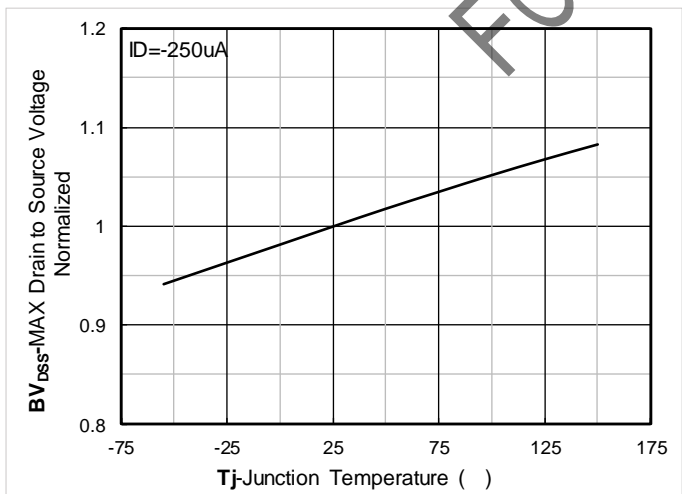


Figure 11. Normalized breakdown voltage

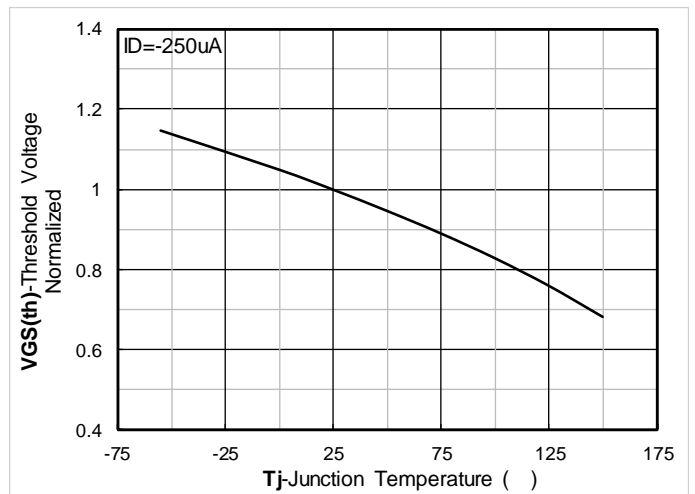


Figure 12. Normalized Threshold voltage

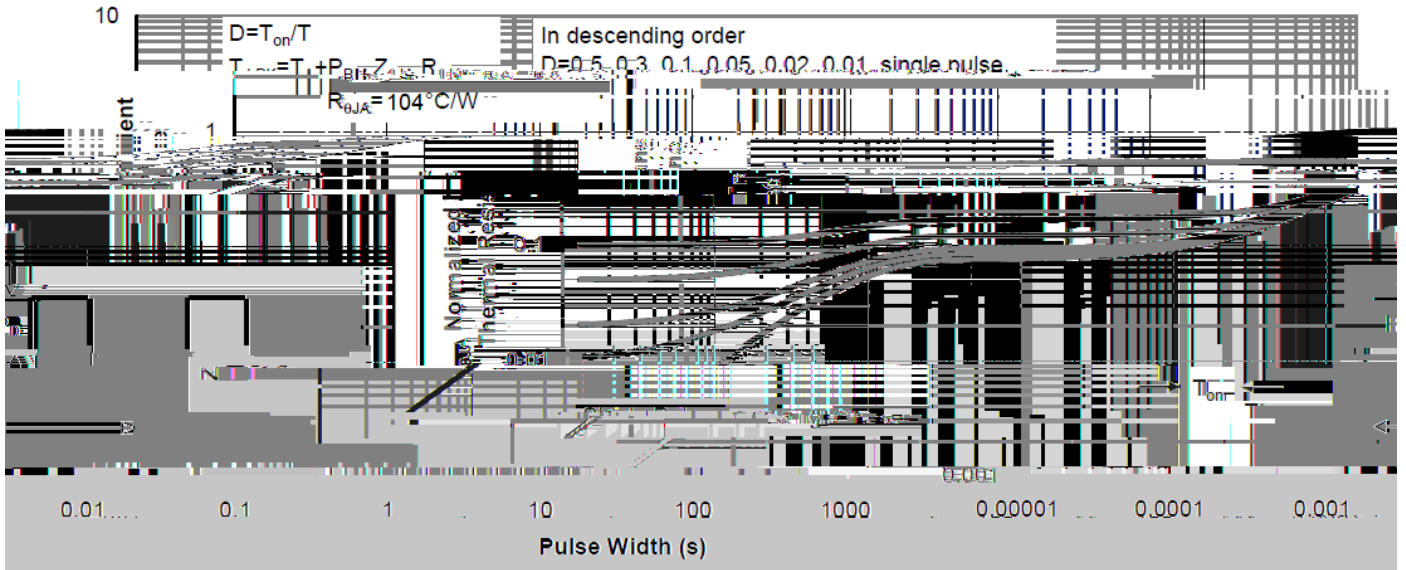


Figure13. Normalized Maximum Transient Thermal Impedance

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